ASSOCIATION CONNEC	Material Composi © Copyright 2005. IPC international and Pan-A	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard  Form Typ  http://www.ipc.org/IPC-175x  Form Typ  Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					eous Materia	ials and Mfg Information			
Supplier Info	rmation														
Company name*				Company unique ID			Unique ID Authority					Response Date*			
nsemi												2024-04-19			
Contact Name		Title - Contact			1	Phone - Contact*				Email - Contact*					
Product-Env-Ste	ewards	Product Enviro Compliance				NA NA				Product-Env-Stewards@onsemi.com					
uthorized Repr	esentative*	Title - Representative			1	Phone - Representative*				Email - Representative*					
Product-Env-Ste	ewards	Product Enviro Compliance				NA NA				Product-Env-Stewards@onsemi.com					
Reque	ester Item Number	LB11867FV-TLM-H 1PH PRI		m Number Mfr Item Name			Effective Da	ite Ve	ersion	Manufacturing Site			Weight*	UOM	Unit Type
					PH PRE SENSOR OPEN ; Single phase re-driver with hall sensor method (open pop speed control)		2024-04-19	РНМ			8	80.0	mg	Each	
<b>Ianufacturi</b> r	ng Proccess Informatio	n													
Termin	Terminal Plating / Grid Array Material			Terminal Base Alloy J-STD-020 I		Rating	Peak Pro	Peak Process Body Temperature Max Time		ime at Peak	Temperat	ure Num	nber of Reflow Cy	vcles	
contains Bi		CU Alloy 3		3		<b>260</b> C		C	30 seco		secon	ds 3			
omments															
TTENTION: M	ASL 3 Rated item requires B	ake and D	ry Pack (after	electrical test)											
or more inform	ation regarding material co	nposition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct tion member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of						
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

<b>Homogeneous Material</b>	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.74	mg	Supplier	Silicon (Si)	7440-21-3		2.7299	mg
			Supplier	Polyimide	Proprietary Data		0.0101	mg
Die Attach	0.56	mg	Supplier	Silver (Ag)	7440-22-4		0.381	mg
			Supplier	Epoxy resins	129915-35-1		0.162	mg
			Supplier	Other Metal Oxide	Proprietary Data		0.0122	mg
			В	Antimony Pentoxide (Sb2O5)	1314-60-9		0.0048	mg
Lead Frame	6.56	mg	Supplier	Silver (Ag)	7440-22-4		0.1312	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0079	mg
			Supplier	Iron (Fe)	7439-89-6		0.1542	mg
			Supplier	Copper (Cu)	7440-50-8		6.2648	mg
			Supplier	Phosphorus (P)	7723-14-0		0.002	mg
Mold Compound-Black	68.63	mg		Epoxy resin	proprietary data		5.1473	mg
			Supplier	Phenolic Resin	Proprietary Data		1.7157	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		5.1473	mg
			Supplier	Carbon Black (C)	1333-86-4		0.3431	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		56.2766	mg
Plating	1.13	mg	В	Bismuth (Bi)	7440-69-9		0.0068	mg
			Supplier	Tin (Sn)	7440-31-5		1.1232	mg
Wire Bond - Au	0.38	mg	Supplier	Gold (Au)	7440-57-5		0.38	mg